PD - 95451

International **ICR** Rectifier

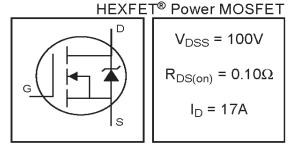
IRL530NPbF

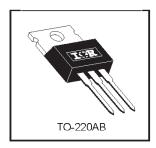
- Logic-Level Gate Drive ۰
- Advanced Process Technology
- Dynamic dv/dt Rating
- 175°C Operating Temperature
- Fast Switching
- Fully Avalanche Rated
- Lead-Free Description

Fifth Generation HEXFETs from International Rectifier utilize advanced processing techniques to achieve extremely low on-resistance per silicon area. This benefit, combined with the fast switching speed and ruggedized device design that HEXFET Power MOSFETs are well known for, provides the designer with an extremely efficient and reliable device for use in a wide variety of applications.

The TO-220 package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 watts. The low thermal resistance and low package cost of the TO-220 contribute to its wide acceptance throughout the industry.

Absolute Maximum Ratings





	Parameter	Max.	Units	
I _D @ T _C = 25°C	Continuous Drain Current, V _{GS} @ 10V	17		
I _D @ T _C = 100°C	Continuous Drain Current, V _{GS} @ 10V	12	A	
I _{DM}	Pulsed Drain Current ①	60		
P _D @T _C = 25°C	Power Dissipation	79	W	
	Linear Derating Factor	0.53	W/°C	
V _{GS}	Gate-to-Source Voltage	± 16	V	
E _{AS}	Single Pulse Avalanche Energy@	150	mJ	
I _{AR}	Avalanche Current®	9.0	A	
E _{AR}	Repetitive Avalanche Energy①	7.9	mJ	
dv/dt	Peak Diode Recovery dv/dt ③	5.0	V/ns	
TJ	Operating Junction and	-55 to + 175		
T _{STG}	Storage Temperature Range		°C	
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)		
	Mounting torque, 6-32 or M3 srew	10 lbf•in (1.1N•m)		

Thermal Resistance

	Parameter	Тур.	Max.	Units
R _{0JC}	Junction-to-Case		1.9	
R _{ecs}	Case-to-Sink, Flat, Greased Surface	0.50		°C/W
Reja	Junction-to-Ambient		62	

	Parameter	Min.	Тур.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	100	—		V	$V_{GS} = 0V, I_{D} = 250 \mu A$
$\Delta V_{(BR)DSS} / \Delta T_{J}$	Breakdown Voltage Temp. Coefficient		0.122		V/°C	Reference to 25°C, I _D = 1mA
				0.100		V _{GS} = 10V, I _D = 9.0A ⊕
R _{DS(on)}	Static Drain-to-Source On-Resistance			0.120	Ω	V _{GS} = 5.0V, I _D = 9.0A ④
				0.150		V _{GS} = 4.0V, I _D = 8.0A ④
$V_{GS(th)}$	Gate Threshold Voltage	1.0		2.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
g fs	Forward Transconductance	7.7			S	V _{DS} = 25V, I _D = 9.0A
1	Drain-to-Source Leakage Current			25		$V_{DS} = 100V, V_{GS} = 0V$
IDSS	Drain-10-300rce Leakage Current			250	μA	$V_{DS} = 80V, V_{GS} = 0V, T_{J} = 150^{\circ}C$
	Gate-to-Source Forward Leakage			100	nA	V _{GS} = 16V
IGSS	Gate-to-Source Reverse Leakage			-100		V _{GS} = -16V
Qg	Total Gate Charge			34		I _D = 9.0A
Q _{gs}	Gate-to-Source Charge			4.8	nC	V _{DS} = 80V
Q _{gd}	Gate-to-Drain ("Miller") Charge			20		V _{GS} = 5.0V, See Fig. 6 and 13 ④
t _{d(on)}	Turn-On Delay Time		7.2			V _{DD} = 50V
tr	Rise Time		53		ns	I _D = 9.0A
t _{d(off)}	Turn-Off Delay Time		30		115	$R_{G} = 6.0\Omega, V_{GS} = 5.0V$
t _f	Fall Time		26			R _D = 5.5Ω, See Fig. 10 ⊕
L _D	Internal Drain Inductance		4.5		nH	Between lead,
						6mm (0.25in.)
L _S	Internal Source Inductance		7.5	—		from package 🔍 🏳 🛃
						and center of die contact
Ciss	Input Capacitance		800			V _{GS} = 0V
Coss	Output Capacitance		160		pF	V _{DS} = 25V
Crss	Reverse Transfer Capacitance		90		1	f = 1.0MHz, See Fig. 5

Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

Source-Drain Ratings and Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions	
Is	Continuous Source Current		47	-	MOSFET symbol		
	(Body Diode)			17	A	showing the	
I _{SM}	Pulsed Source Current				~~		integral reverse 🛛 🖓 🗖
	(Body Diode) ①⑥			60		p-n junction diode.	
V _{SD}	Diode Forward Voltage			1.3	V	T_{J} = 25°C, I_{S} = 9.0A, V_{GS} = 0V \oplus	
trr	Reverse Recovery Time		140	210	ns	$T_J = 25^{\circ}C, I_F = 9.0A$	
Qrr	Reverse RecoveryCharge		740	1100	nC	di/dt = 100A/µs ⊛	
t _{on}	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by L_S + L_D)					

Notes:

① Repetitive rating; pulse width limited by max.junction temperature. (See fig. 11)

② Starting T_J = 25°C, L = 3.7mH

 $R_{G} = 25\Omega$, $I_{AS} = 9.0A$. (See Figure 12)

(3) I_{SD} \leq 9.0A, di/dt \leq 540A/µs, V_{DD} \leq V_{(BR)DSS}, T_{\rm J} \leq 175°C

3 Pulse width $\leq 300 \mu s;$ duty cycle $\leq 2\%$

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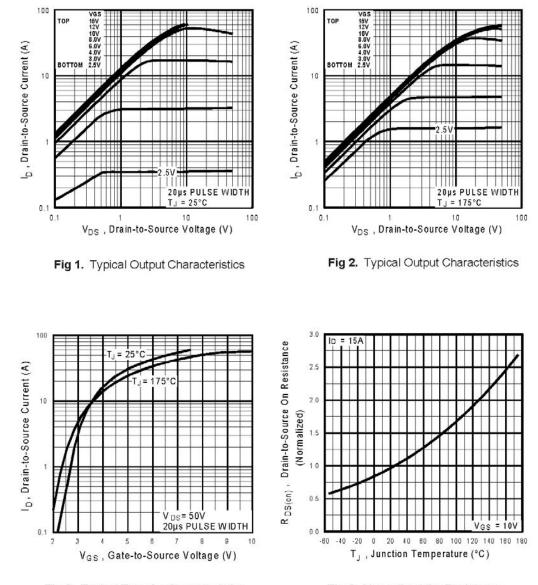


Fig 3. Typical Transfer Characteristics

Fig 4. Normalized On-Resistance Vs. Temperature

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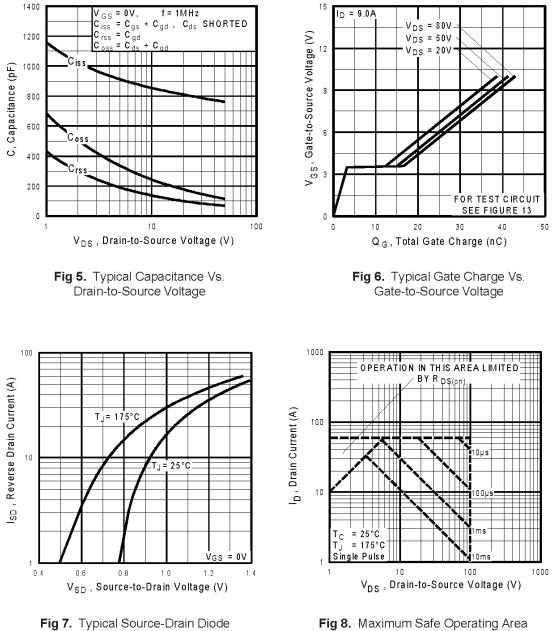


Fig 7. Typical Source-Drain Diode Forward Voltage

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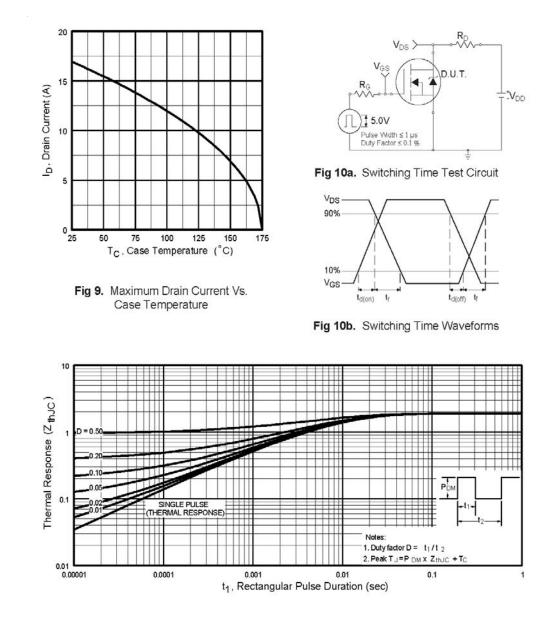


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

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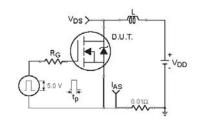


Fig 12a. Unclamped Inductive Test Circuit

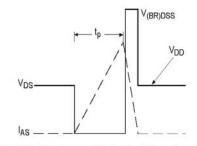


Fig 12b. Unclamped Inductive Waveforms

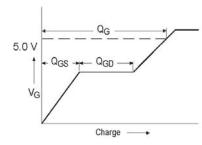


Fig 13a. Basic Gate Charge Waveform

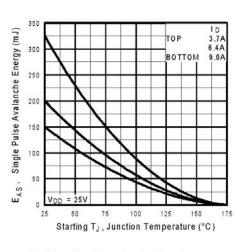


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

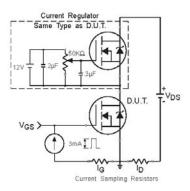
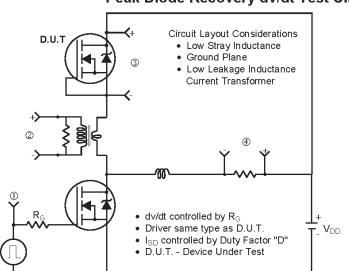
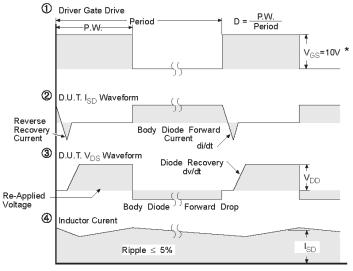


Fig 13b. Gate Charge Test Circuit



Peak Diode Recovery dv/dt Test Circuit



* V_{GS} = 5V for Logic Level Devices

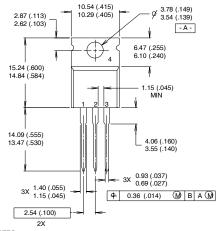
Fig 14. For N-Channel HEXFETS

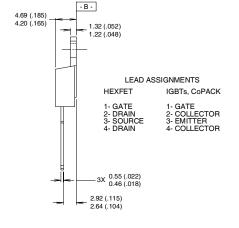
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TO-220AB Package Outline

Dimensions are shown in millimeters (inches)



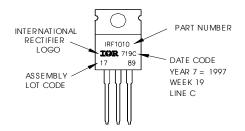


NOTES:

1 DIMENSIONING & TOLERANCING PER ANSI Y14.5M, 1982. 2 CONTROLLING DIMENSION : INCH 3 OUTLINE CONFORMS TO JEDEC OUTLINE TO-220AB. 4 HEATSINK & LEAD MEASUREMENTS DO NOT INCLUDE BURRS.

TO-220AB Part Marking Information

EXAMPLE: THIS IS AN IRF1010 LOT CODE 1789 ASSEMBLED ON WW 19, 1997 IN THE ASSEMBLY LINE "C" Note: "P" in assembly line position indicates "Lead-Free"



TO-220AB package is not recommended for Surface Mount Application.

Data and specifications subject to change without notice.

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